



**Silicon Motion, Inc.**

## **SM32X Test Program and ISP Release Note**

**SM3257 Test Program and ISP Release Note:**

Release Date	ISP Version	ISP Check Sum	Test AP Version	Description
2010/06/07	SM3257AA 2010-06-07	SM3257AAISP 0x005ABF6E	V2.03.28 V5 10/06/07 build	1. SM3257AAISP support Samsung 32nm TLC bucket00 flash K9ABG08U0A, K9BCG08U1A and K9CDG08U5A 2. SM3257AAISP support Samsung 27nm MLC K9GBG08U0A 3. SM3257AAISP-bucket01 support Samsung 32nm TLC bucket01 flash K9ABG08U0A, K9BCG08U1A and K9CDG08U5A.
2010/07/02	SM3257AA 2010-07-02	SM3257AAISP 0x005D3C3E SM3257AAISP-bucket01 0x005D12F0	V2.03.29 V3 10/07/02 build	1. SM3257AAISP support Samsung 32nm MLC 2. SM3257AAISP support Intel/Micron L74A 3. SM3257AAISP support Intel/Micron L73A 4. SM3257AAISP enhance suddenly power cycling protection 5. SM3257AAISP-bucket01 enhance suddenly power cycling protection 6. SM3257AAISP support Hynix 26nm MLC. 7. MP tool fixed device disconnection issue when MP tool initial card.
2010/08/18	SM3257AA 2010-08-09 SM3257AA 2010-08-16 SM3257AA 2010-08-09	SM3257AAISP 0x005D3AEF SM3257AAISP-bucket01 0x005D9003 SM3257AAISP-HY32 0x005D8449	V2.03.31 V1 10/08/18 build	1. SM3257AAISP, SM3257AAISP-bucket01 and SM3257AAISP-HY32 fixed power cycling issue to cause system block occurs ECC fail. 2. SM3257AAISP, SM3257AAISP-bucket01 and SM3257AAISP-HY32 fixed build link block issue when plug in UFD. 3. SM3257AAISP support Hynix 26nm MLC H27UCG8T2MYR. 4. SM3257AAISP-HY32 support Hynix 32nm TLC H27UBG8M2A.



				<ul style="list-style-type: none"><li>5. MP tool fixed update ISO issue (CDROM + Public mode change to Public only mode without do-pretest).</li><li>6. MP tool add QC function which check capacity and used space.</li><li>7. MP tool add Multiple Erase all function.</li></ul>
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